

Vishay Siliconix

P-Channel 8 V (D-S) MOSFET

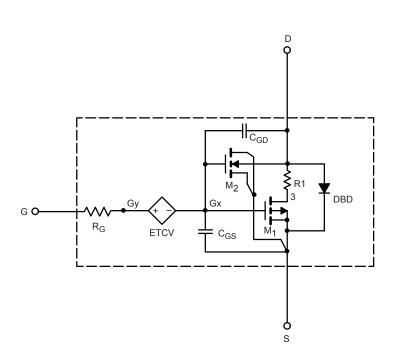
DESCRIPTION

The attached SPICE model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 °C to + 125 °C temperature ranges under the pulsed 0 V to 5 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage. A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC

CHARACTERISTICS

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- · Apply for both Linear and Switching Application
- Accurate over the 55 °C to + 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics



Note

This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

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SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted					
PARAMETER	SYMBOL	TEST CONDITIONS	SIMULATED DATA	MEASURED DATA	UNIT
Static					
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	0.5	-	V
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4.4 \text{ A}$	0.028	0.028	Ω
		V_{GS} = - 2.5 V, I _D = - 3.8 A	0.037	0.039	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -4 V, I_{D} = -4.4 A$	16	17	S
Diode Forward Voltage ^a	V _{SD}	I _S = - 3.5 A	- 0.74	- 0.80	V
Dynamic ^b	•	•	•	· · · · · · · · · · · · · · · · · · ·	
Input Capacitance	C _{iss}	$V_{DS} = -4 V$, $V_{GS} = 0 V$, f = 1 MHz	961	960	pF
Output Capacitance	C _{oss}		333	330	
Reverse Transfer Capacitance	C _{rss}		296	300	
Total Gate Charge	Qg	$V_{DS} = -4 V, V_{GS} = -8 V, I_{D} = -4.4 A$	15	20	
			9.3	12	
Gate-Source Charge	Q _{gs}	$V_{DS} = -4 V$, $V_{GS} = -4.5 V$, $I_D = -4.4 A$	1.5	1.5	nC
Gate-Drain Charge	Q _{gd}		3.1	3.1	

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

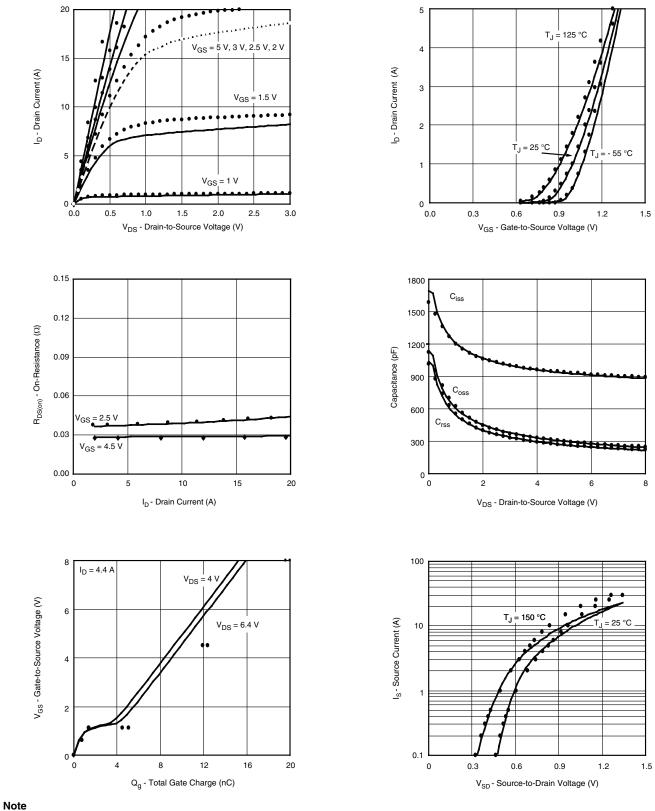
b. Guaranteed by design, not subject to production testing.



SPICE Device Model Si2305CDS

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COMPARISON OF MODEL WITH MEASURED DATA $T_J = 25$ °C, unless otherwise noted

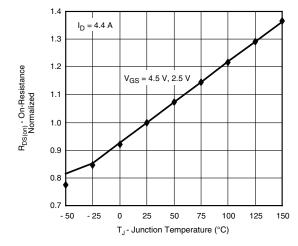


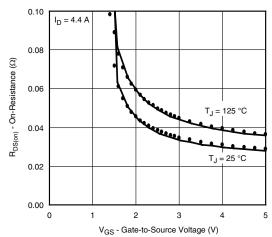
Dots and squares represent measured data.

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COMPARISON OF MODEL WITH MEASURED DATA T_J = 25 °C, unless otherwise noted







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